

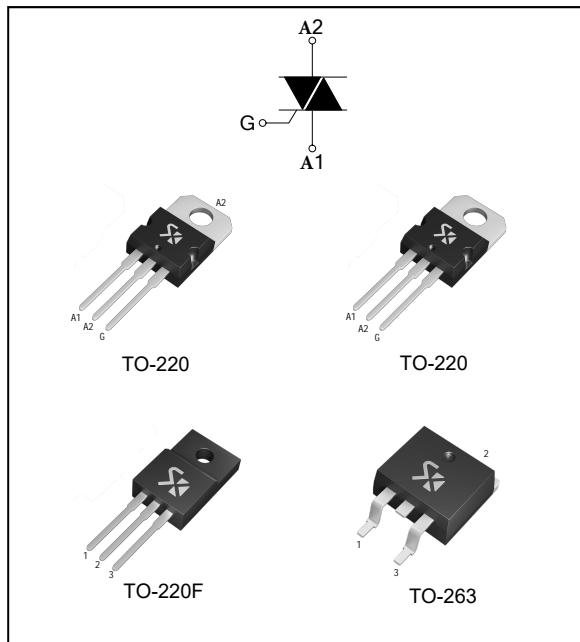
Silicon Controlled Rectifier

Features

- NPNPN four-layer silicon unidirectional device;
- With independent intellectual property rights of single-side grooving technology, table glass passivation process;
- Multilayer metallized electrode on the back;
- High blocking voltage and high temperature stability

Application

- Solid state relay;
- Phase-controlled circuit;
- Adjustable heating controller;
- Speed control controller;



■ ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER		RATINGS	UNIT	
$I_{T(RMS)}$	RMS On-State Current	BTA BTB	$T_c=80^\circ\text{C}$ $T_c=90^\circ\text{C}$	16	A
I_{TSM}	Non Repetitive Surge Peak On-State Current	F=50HZ	t=20ms	160	A
I^2t	I^2t Value	tp=10ms		144	A^2s
di/dt	Critical Rate of Rise of On-State Current		$T_j=125^\circ\text{C}$	50	$\text{A}/\mu\text{s}$
V_{DRM}/V_{RRM}	Repetitive Peak Off-State Voltage		$T_j=25^\circ\text{C}$	600/800	V
I_{GM}	Peak Gate Current	tp=20us	$T_j=125^\circ\text{C}$	4	A
$P_{G(AV)}$	Average Gate Power Dissipation		$T_j=125^\circ\text{C}$	1	W
T_{stg} T_j	Storage Junction Temperature Operating Junction Temperature		−40 to +150 −40 to +125	°C	

■ Electrical characteristics (three quadrants)

PARAMETER	SYMBOL	TEST CONDITIONS	Quadrants		RATINGS		UNIT	
Gate Trigger Current	I _{GT}	V _D =12V (DC) R _L =100Ω	I II III	MAX	≤ 50		mA	
Gate Trigger Voltage	V _{GT}			MAX	1.5		V	
GateNon-Trigger Voltage	V _{GD}			MIN	0.2		V	
HoldingCurrent	I _H	I _T =0.5A		MAX	60		mA	
Latching Current	I _L	I _G =1.2I _{GT}		MAX	I -III	60	mA	
Critical Rate of Rise of Off-State Voltage at Commutation	(dv/dt)c	T _j =125°C			II	100		
Critical Rate of Rise of Off-State Voltage	dv/dt	V _D =2/3V _{DRM} T _j =125°C		MIN	500		V/us	

■ Electrical characteristics (four quadrants)

PARAMETER	SYMBOL	TEST CONDITIONS	Quadrants		RATINGS		UNIT			
Gate Trigger Current	I _{GT}	V _D =12V R _L =100 Ω	I II III IV	MAX	I	II III	mA			
Gate Trigger Voltage	V _{GT}				≤ 50	≤ 120				
GateNon-Trigger Voltage	V _{GD}	T _j =125°C		MAX	1.5		V			
HoldingCurrent	I _H	I _T =0.5A			0.2					
Latching Current	I _L	I _G =1.2I _{GT}			60					
Critical Rate of Rise of Off-State Voltage at Commutation	(dv/dt)c	T _j =125°C		MIN	100		V/us			
Critical Rate of Rise of Off-State Voltage	dv/dt	V _D =2/3V _{DRM} T _j =125°C		MIN	500					

■ Static parameters

SYMBOL	PARAMETER		RATINGS	UNIT
V _{TM}	Peak On-State Voltage	T _j =25°C ITM=32A	MAX	1.50
V _{T0}	Threshold voltage	T _j =125°C	MAX	0.87
R _d	Resistance	T _j =125°C	MAX	14.6
I _{DRM} I _{RRM}	Repetitive Peak Off-State Current	T _j =25°C T _j =125°C	MAX	5
				1
R _{th(j-c)}	Junction to Case (DC)	BTA		2.10
		BTB		1.30
				°C/W

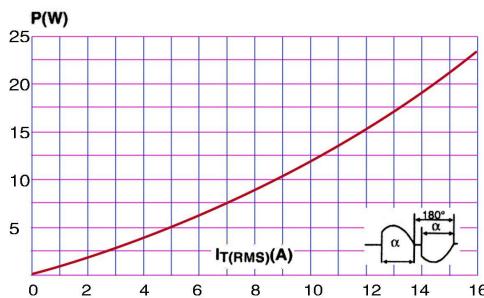


FIG.1: Maximum power dissipation versus RMS on-state current

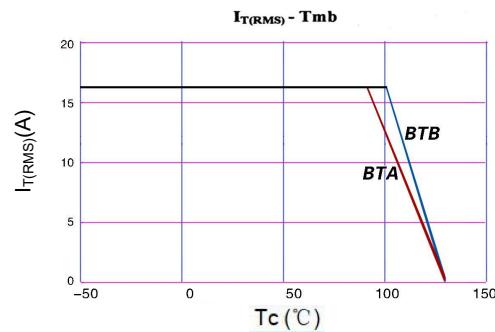


FIG.2: RMS on-state current versus case temperature

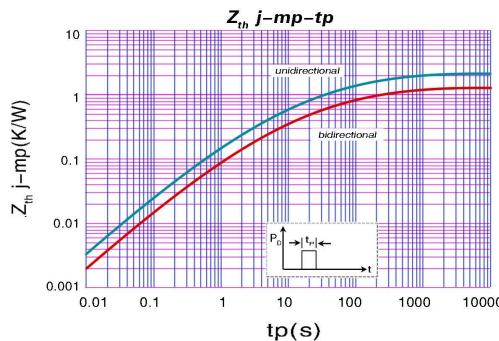


FIG.3: Transient thermal resistance diagram

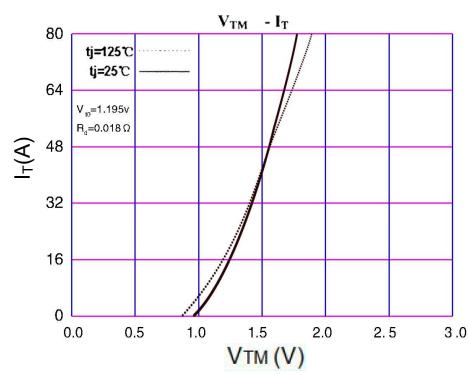


FIG.4: On-state characteristics (maximum values)

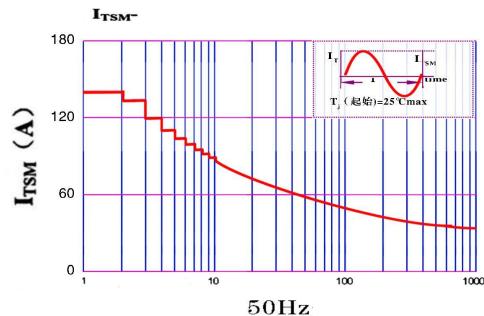


FIG.5: Surge peak on-state current versus number of cycles

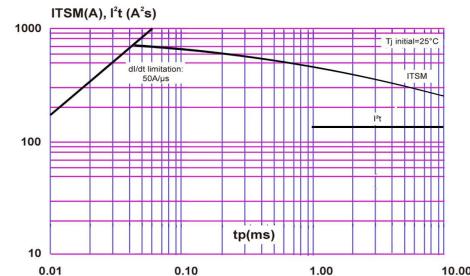


FIG.6: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $tp < 20\text{ms}$, and corresponding value of I^2t .

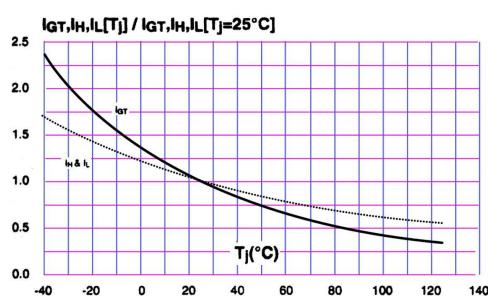
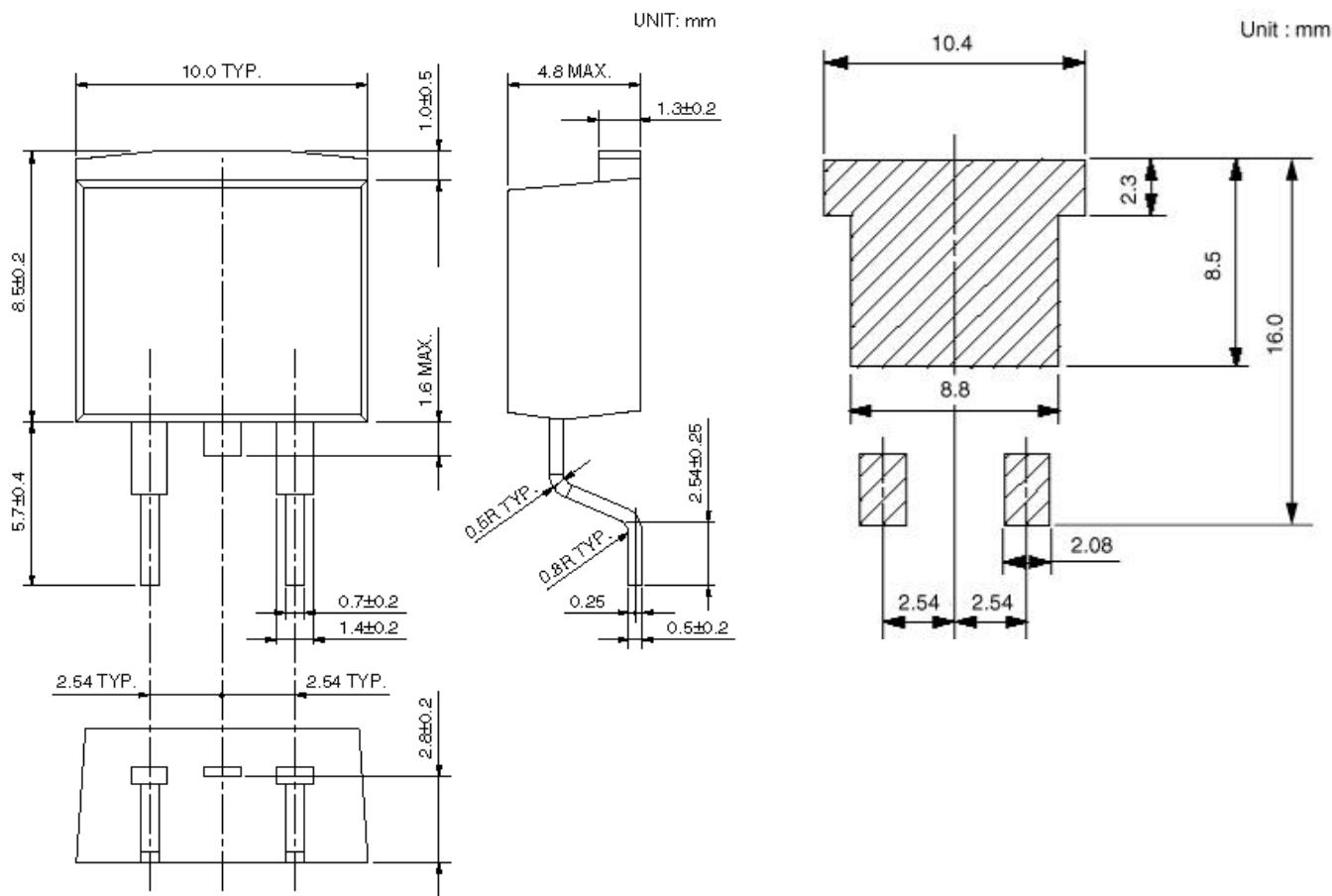


FIG.7: Relative variations of gate trigger current, holding current and latching current versus junction temperature

PACKAGE OUTLINE

Plastic surface mounted package;

TO-263
●Unit: mm(± 0.1)


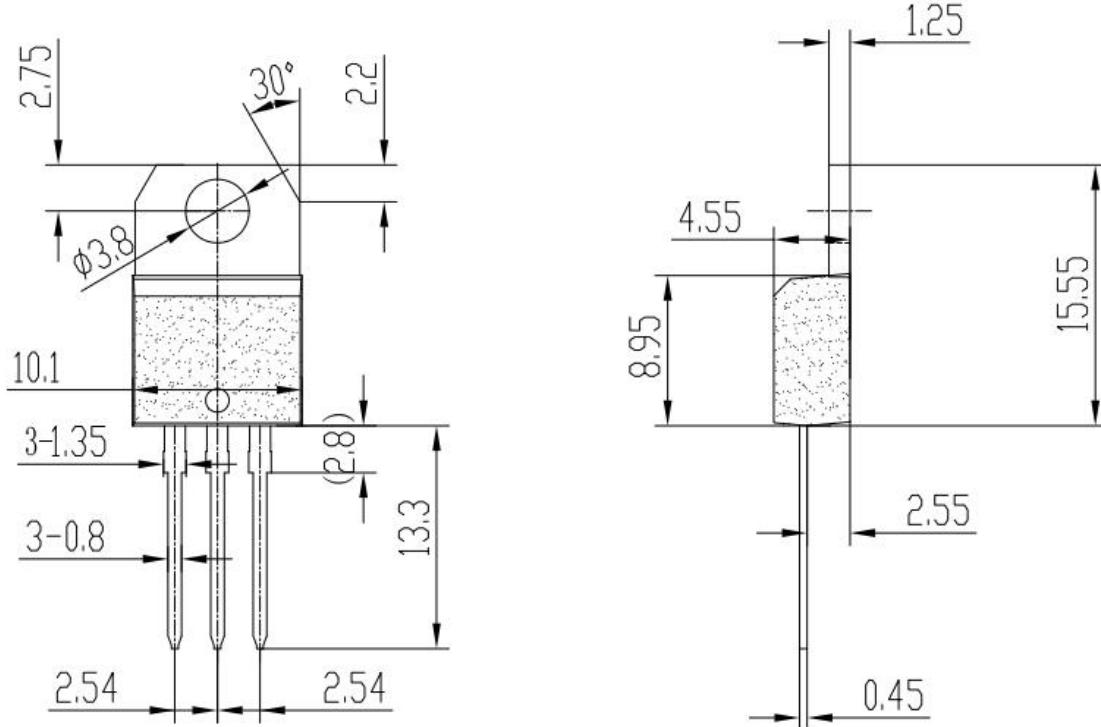
: The area without solder plated

PACKAGE OUTLINE

Plastic surface mounted package;

TO-220

●Unit: mm(± 0.1)

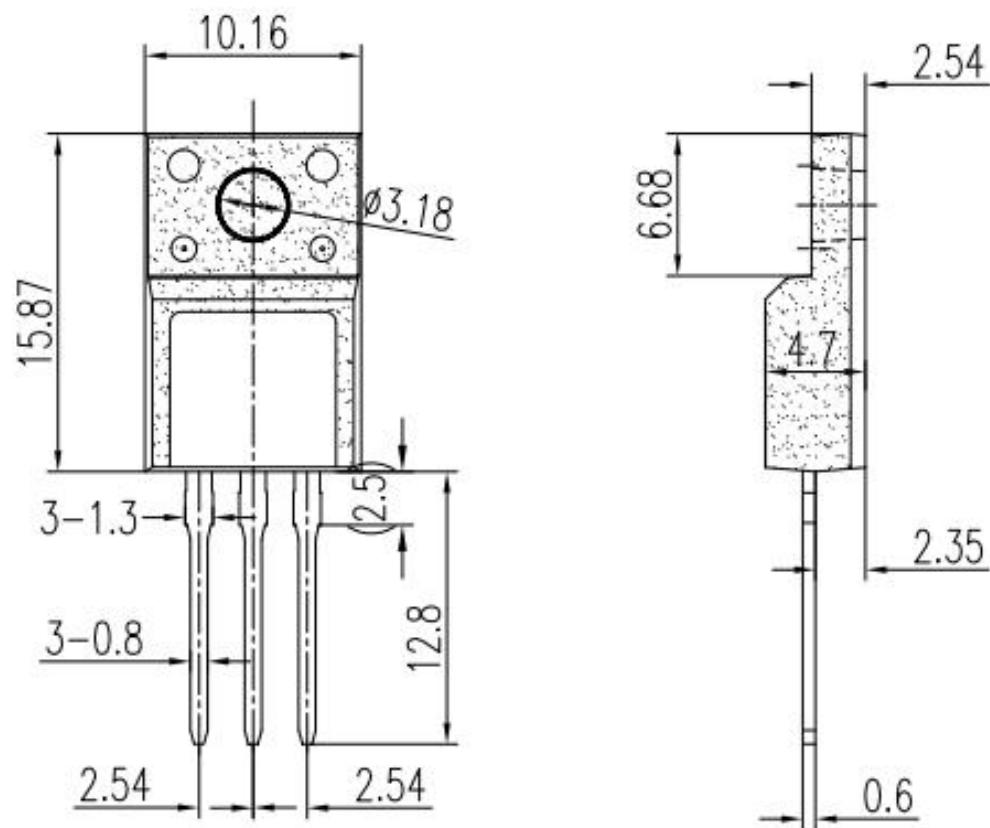


PACKAGE OUTLINE

Plastic surface mounted package;

TO-220F

●Unit: mm(± 0.1)



● Product marking comments:

BT 139 - 800
Silicon Controlled Rectifier
VDRM/VRRM ≥ 800V
IT(RMS):16A

A2039I “W” —— three quadrants
 “Blank” —— four quadrants

Production cycle

XXXXXX _____ Production batch number